## **SIEMENS**

## **Data sheet**

6ES7677-2VB42-0GB0



SIMATIC ET 200SP Open Controller, CPU 1515SP PC2 T, 8 GB RAM, 128 GB CFast with Windows 10 IoT Enterprise 64-bit and S7-1500 Software Controller CPU 1505SP T pre-installed, Interfaces: 1x Slot CFast, 1x slot SD/MMC, 1x connection for ET 200SP bus Adapter PROFINET, 1x 10/100/1000 Mbit/s Ethernet, 2x USB 3.0, 2x USB 2.0, 1x display port, Documentation on CFast Restore image on CFast

General information	
Product type designation	CPU 1515SP PC2 T
HW functional status	from FS04
Engineering with	
STEP 7 TIA Portal configurable/integrated from version	STEP 7 V16 or higher
Installed software	
<ul> <li>Visualization</li> </ul>	No
Control	S7-1500 Software Controller CPU 1505SP T
Configuration control	
via dataset	Yes
Control elements	
Mode selector switch	1
Supply voltage	
Type of supply voltage	24 V DC
permissible range, lower limit (DC)	19.2 V
permissible range, upper limit (DC)	28.8 V
Reverse polarity protection	Yes
Mains buffering	
<ul> <li>Mains/voltage failure stored energy time</li> </ul>	5 ms
Input current	
Current consumption (rated value)	1.8 A; Full processor load, incl. ET 200SP modules and using USB
Current consumption (in no-load operation), typ.	0.5 A
Current consumption, max.	2.9 A
²t	0.426 A <sup>2</sup> ·s; with starting current inrush
Power	
Active power input, max.	43 W; incl. ET 200SP modules and using USB
Infeed power to the backplane bus	8.75 W
Power loss	
Power loss, typ.	16 W
Processor	
Processor type	Intel Atom E3940, 1.6 GHz, 4 cores
Memory	
Type of memory	DDR3L
Main memory	8 GB RAM
CFast memory card	Yes; 30 GB flash memory
SIMATIC memory card required	No

Work memory	
• integrated (for program)	1 Mbyte
<ul><li>integrated (for data)</li></ul>	5 Mbyte
<ul> <li>integrated (for CPU function library of CPU Runtime)</li> </ul>	20 Mbyte
Load memory	
• integrated (on PC mass storage)	320 Mbyte
Backup	
• with UPS	Yes; all memory areas declared retentive
with non-volatile memory	Yes
CPU processing times	
for bit operations, typ.	10 ns
for word operations, typ.	12 ns
for fixed point arithmetic, typ.	16 ns
for floating point arithmetic, typ.	64 ns
CPU-blocks	
Number of elements (total)	6 000; In addition to blocks such as DBs, FBs and FCs, UDTs, global
DR	constants, etc. are also regarded as elements
DB Number may	F 000: Number represed 4 to 05505
Number, max.     Circ. may.	5 999; Number range: 1 to 65535
• Size, max.	5 Mbyte
FB	5 000 N. J. 05505
Number, max.	5 998; Number range: 1 to 65535
• Size, max.	1 024 kbyte
FC	
Number, max.	5 999; Number range: 1 to 65535
• Size, max.	1 024 kbyte
OB	
• Size, max.	1 024 kbyte
Number of free cycle OBs	100
<ul> <li>Number of time alarm OBs</li> </ul>	20
<ul> <li>Number of delay alarm OBs</li> </ul>	20
<ul> <li>Number of cyclic interrupt OBs</li> </ul>	20
<ul> <li>Number of process alarm OBs</li> </ul>	50
<ul> <li>Number of DPV1 alarm OBs</li> </ul>	3
<ul> <li>Number of isochronous mode OBs</li> </ul>	1
<ul> <li>Number of technology synchronous alarm OBs</li> </ul>	2
<ul> <li>Number of startup OBs</li> </ul>	100
<ul> <li>Number of asynchronous error OBs</li> </ul>	4
<ul> <li>Number of synchronous error OBs</li> </ul>	2
Number of diagnostic alarm OBs	1
Nesting depth	
<ul> <li>per priority class</li> </ul>	24
Counters, timers and their retentivity	
S7 counter	
Number	2 048
Retentivity	
— adjustable	Yes
IEC counter	
Number	Any (only limited by the main memory)
Retentivity	
— adjustable	Yes
S7 times	
Number	2 048
Retentivity	
— adjustable	Yes
IEC timer	
Number	Any (only limited by the main memory)

Retentivity	
— adjustable	Yes
Data areas and their retentivity	
Retentive data area (incl. timers, counters, flags), max.	410 kbyte; For storage in NVRAM; for storage in mass storage 5 242
-	020 bytes
Flag	
• Size, max.	16 kbyte
Number of clock memories	8; 8 clock memory bit, grouped into one clock memory byte
Data blocks	
Retentivity adjustable	Yes
Retentivity preset	No
Local data	0.444 4 40.475 44 4
per priority class, max.	64 kbyte; max. 16 KB per block
Address area	
Number of IO modules	8 192
I/O address area	
<ul><li>Inputs</li></ul>	32 kbyte; All inputs are in the process image
Outputs	32 kbyte; All outputs are in the process image
Subprocess images	
Number of subprocess images, max.	32
Hardware configuration	
Integrated power supply	Yes
Number of distributed IO systems	20
Number of DP masters	
• Via CM	1
Number of IO Controllers	
via PC interfaces	1
Rack	
<ul> <li>Modules per rack, max.</li> </ul>	64; CPU 1515SP PC + 64 modules + server module
<ul> <li>Quantity of operable ET 200SP modules, max.</li> </ul>	64
<ul> <li>Quantity of operable ET 200AL modules, max.</li> </ul>	16
Number of lines, max.	1
PtP CM	
<ul> <li>Number of PtP CMs</li> </ul>	the number of connectable PtP CMs is only limited by the number of available slots
Time of day	
Clock	
• Type	Hardware clock
Hardware clock (real-time)	Yes; Resolution: 1 s
Backup time	6 wk; At 40 °C ambient temperature, typically
Deviation per day, max.	10 s; Typ.: 2 s
Clock synchronization	
• supported	Yes
• to DP, master	Yes
on Ethernet via NTP	Yes
<ul> <li>on Windows clock, slave</li> </ul>	Yes
Interfaces	
Number of industrial Ethernet interfaces	2
Number of PROFINET interfaces	1
Number of PROFIBUS interfaces	1
Number of RS 485 interfaces	1; Via CM DP module
Number of USB interfaces	4; 2x USB 2.0, 2x USB 3.0 on front side
Number of SD card slots	1
Video interfaces	
Graphics interface	1x DisplayPort
1. Interface	
automatic detection of transmission rate	Yes
Autonegotiation	Yes
-9	

Autocrossing	Yes
Number of connections	88
Interface types	
• RJ 45 (Ethernet)	Yes; Via BusAdapter BA 2x RJ45
— Transmission rate, max.	100 Mbit/s
Industrial Ethernet status LED	Yes
Number of ports	2
• integrated switch	Yes
BusAdapter (PROFINET)	Yes; Compatible BusAdapter: BA 2x RJ45, BA 2x FC, BA 2x SCRJ (from FS03, V2.2), BA SCRJ / RJ45 (from FS03, V3.1), BA SCRJ / FC (from FS03, V3.1), BA 2x LC (from FS03, V3.3), BA LC / RJ45 (from FS03, V3.3), BA LC / FC (from FS03, V3.3)
Protocols	
PROFINET IO Controller	Yes
PROFINET IO Device	Yes
SIMATIC communication	Yes
Open IE communication	Yes
Web server	Yes
PROFINET IO Controller	
Services	
— Isochronous mode	Yes
— shortest clock pulse	500 μs
— IRT	Yes
— PROFlenergy	Yes
— Prioritized startup	Yes; max. 32 PROFINET devices; if you want to use the "Prioritized startup" functionality in STEP 7 for the PROFINET interface of the CPU, the CPU and the device must be separated by means of a switch (e.g. SCALANCE X205)
<ul> <li>Number of connectable IO Devices, max.</li> </ul>	128
<ul> <li>Of which IO devices with IRT, max.</li> </ul>	64
— of which in line, max.	64
<ul> <li>Number of connectable IO Devices for RT, max.</li> </ul>	128
— of which in line, max.	128
Number of IO Devices that can be simultaneously activated/deactivated, max.	8
<ul> <li>IO Devices changing during operation (partner ports), supported</li> </ul>	Yes
Number of IO Devices per tool, max.	8
— Updating times	The minimum value of the update time also depends on communication share set for PROFINET IO, on the number of IO devices, and on the quantity of configured user data
Update time for IRT	
— for send cycle of 500 μs	500 μs to 8 ms
— for send cycle of 1 ms	1 ms to 16 ms
— for send cycle of 2 ms	2 ms to 32 ms
— for send cycle of 4 ms	4 ms to 64 ms
<ul> <li>With IRT and parameterization of "odd" send cycles</li> </ul>	Update time = set "odd" send clock (any multiple of 125 $\mu$ s: 375 $\mu$ s, 625 $\mu$ s 3 875 $\mu$ s)
Update time for RT	μο ο οι ο μο,
— for send cycle of 500 μs	500 μs to 256 ms
— for send cycle of 1 ms	1 ms to 512 ms
— for send cycle of 2 ms	2 ms to 512 ms
— for send cycle of 4 ms	4 ms to 512 ms
Address area	
— Inputs, max.	8 kbyte
— Outputs, max.	8 kbyte
PROFINET IO Device	
Services	
— Isochronous mode	No
<ul> <li>shortest clock pulse</li> </ul>	500 μs
,	

— IRT	Yes
— PROFlenergy	Yes
<ul> <li>Prioritized startup</li> </ul>	Yes
<ul> <li>Shared device</li> </ul>	Yes
<ul> <li>Number of IO Controllers with shared device,</li> </ul>	4
max.	Yes
Asset management record  2. Interface	165
	Integrated Ethernet interface
Interface type automatic detection of transmission rate	Integrated Ethernet interface Yes
	Yes
Autonogotiation	
Autocrossing Interface types	Yes
• RJ 45 (Ethernet)	Voc. Integrated
— Transmission rate, max.	Yes; Integrated 1 000 Mbit/s
Industrial Ethernet status LED	No
Number of ports	1
3. Interface	
Interface type	PROFIBUS with CM DP
Number of connections via this interface	44
Interface types	
• RS 485	Yes
Protocols	
<ul> <li>PROFIBUS DP master</li> </ul>	Yes
<ul> <li>PROFIBUS DP slave</li> </ul>	Yes
SIMATIC communication	Yes
PROFIBUS DP master	
<ul> <li>Number of DP slaves, max.</li> </ul>	125
Services	
— Equidistance	No
— Isochronous mode	No
Address area	
— Inputs, max.	8 kbyte
— Outputs, max.	8 kbyte
Interface types	
RS 485	
Transmission rate, max.	12 Mbit/s
Protocols	
Number of connections	
<ul> <li>Number of connections, max.</li> </ul>	88
<ul> <li>Number of connections reserved for ES/HMI/web</li> </ul>	10
Number of S7 routing paths	16
Redundancy mode	
Media redundancy	
<ul> <li>Switchover time on line break, typ.</li> </ul>	200 ms
— Number of stations in the ring, max.	50
SIMATIC communication	
<ul> <li>PG/OP communication</li> </ul>	Yes
S7 routing	Yes
<ul> <li>S7 communication, as server</li> </ul>	Yes
<ul> <li>S7 communication, as client</li> </ul>	Yes
User data per job, max.	64 kbyte; BSEND/BRCV: 64 KB; PUT/GET: 960 bytes
Open IE communication	
• TCP/IP	Yes
— Data length, max.	64 kbyte
• ISO-on-TCP (RFC1006)	Yes
— Data length, max.	64 kbyte
• UDP	Yes

— Data length, max.	1 472 kbyte
• SNMP	Yes
• DCP	Yes
• LLDP	Yes
Web server	
• HTTP	Yes; Via Windows and PROFINET interface
• HTTPS	Yes; Via Windows and PROFINET interface
OPC UA	
Runtime license required	Yes; "Small" license required
OPC UA Client	Yes; From SW CPU 1505SP V2.6
<ul> <li>Application authentication</li> </ul>	No
OPC UA Server	Yes; Data access (read, write, subscribe), runtime license required
<ul> <li>Application authentication</li> </ul>	Yes; Available security policies: None, Basic128Rsa15, Basic256Rsa15, Basic256Sha256
— Security policies	Yes; Available security policies: None, Basic128Rsa15, Basic256Rsa15, Basic256Sha256
— User authentication	Yes; "anonymous" or by user name & password
Further protocols	
• MODBUS	Yes; MODBUS TCP
S7 message functions	
Number of login stations for message functions, max.	32
Program alarms	Yes
Number of configurable program messages, max.	10 000
Number of simultaneously active program alarms	1 000
<ul> <li>Number of program alarms</li> </ul>	1 000
<ul> <li>Number of alarms for system diagnostics</li> </ul>	200
<ul> <li>Number of alarms for motion technology objects</li> </ul>	160
Test commissioning functions	
Joint commission (Team Engineering)	Yes; Parallel online access possible for up to 8 engineering systems
Status block	Yes; up to 8 simultaneously
Single step	No
Number of breakpoints	8
Status/control	
<ul> <li>Status/control variable</li> </ul>	Yes
<ul> <li>Variables</li> </ul>	Inputs, outputs, memory bits, DB, times, counters
<ul> <li>Number of variables, max.</li> </ul>	
<ul><li>of which status variables, max.</li></ul>	200
<ul> <li>of which control variables, max.</li> </ul>	200
Forcing	
Forcing	Yes
<ul> <li>Forcing, variables</li> </ul>	Inputs, outputs
<ul> <li>Number of variables, max.</li> </ul>	200
Number of variables, max.  Diagnostic buffer	200
	Yes
Diagnostic buffer	
Diagnostic buffer  • present	Yes
Diagnostic buffer  • present  • Number of entries, max.	Yes 1 000
Diagnostic buffer  • present  • Number of entries, max.  — of which powerfail-proof	Yes 1 000
Diagnostic buffer  • present  • Number of entries, max.  — of which powerfail-proof  Traces	Yes 1 000 300
Diagnostic buffer  • present  • Number of entries, max.  — of which powerfail-proof  Traces  • Number of configurable Traces	Yes 1 000 300
Diagnostic buffer  • present  • Number of entries, max.  — of which powerfail-proof  Traces  • Number of configurable Traces  • Memory size per trace, max.	Yes 1 000 300
Diagnostic buffer  • present  • Number of entries, max.  — of which powerfail-proof  Traces  • Number of configurable Traces  • Memory size per trace, max.  Interrupts/diagnostics/status information	Yes 1 000 300
Diagnostic buffer  • present  • Number of entries, max.  — of which powerfail-proof  Traces  • Number of configurable Traces  • Memory size per trace, max.  Interrupts/diagnostics/status information  Diagnostics indication LED	Yes 1 000 300 4 512 kbyte
Diagnostic buffer  • present  • Number of entries, max.  — of which powerfail-proof  Traces  • Number of configurable Traces  • Memory size per trace, max.  Interrupts/diagnostics/status information  Diagnostics indication LED  • RUN/STOP LED	Yes 1 000 300 4 512 kbyte
Diagnostic buffer  • present  • Number of entries, max. — of which powerfail-proof  Traces  • Number of configurable Traces • Memory size per trace, max.  Interrupts/diagnostics/status information  Diagnostics indication LED  • RUN/STOP LED  • ERROR LED  • MAINT LED	Yes 1 000 300  4 512 kbyte  Yes Yes
Diagnostic buffer  • present  • Number of entries, max.  — of which powerfail-proof  Traces  • Number of configurable Traces  • Memory size per trace, max.  Interrupts/diagnostics/status information  Diagnostics indication LED  • RUN/STOP LED  • ERROR LED	Yes 1 000 300  4 512 kbyte  Yes Yes Yes Yes
Diagnostic buffer  • present  • Number of entries, max.  — of which powerfail-proof  Traces  • Number of configurable Traces  • Memory size per trace, max.  Interrupts/diagnostics/status information  Diagnostics indication LED  • RUN/STOP LED  • ERROR LED  • MAINT LED  Supported technology objects	Yes 1 000 300  4 512 kbyte  Yes Yes

Required Motion Control resources	
	40: per evie
per speed-controlled axis	40; per axis 80; per axis
<ul><li>— per positioning axis</li><li>— per synchronous axis</li></ul>	160; per axis
— per synchronous axis  — per external encoder	80; per external encoder
— per external encoder  — per output cam	20; per cam
— per cam track	160; per cam track
— per carritack  — per probe	40; per can track
Number of available Extended Motion Control	120
resources for technology objects	120
Required Extended Motion Control resources	
— per cam (1 000 points and 50 segments)	2
— for each set of kinematics	30
<ul> <li>Per leading axis proxy</li> </ul>	3
<ul> <li>Positioning axis</li> </ul>	
<ul> <li>Number of positioning axes at motion control cycle of 4 ms (typical value)</li> </ul>	30
<ul> <li>Number of positioning axes at motion control cycle of 8 ms (typical value)</li> </ul>	30
Controller	
<ul><li>PID_Compact</li></ul>	Yes; Universal PID controller with integrated optimization
PID_3Step	Yes; PID controller with integrated optimization for valves
PID-Temp	Yes; PID controller with integrated optimization for temperature
Counting and measuring	
High-speed counter	Yes
Standards, approvals, certificates	
CE mark	Yes
CSA approval	Yes
cULus	Yes
FM approval	Yes
DOM (C   O TIOIO	Voc
RCM (formerly C-TICK)	Yes
Ambient conditions	Tes
	Tes
Ambient conditions	-20 °C
Ambient conditions  Ambient temperature during operation  • min.  • max.	-20 °C Up to 60 °C with max. 32 ET 200SP modules; up to 55 °C with max. 64 ET 200SP modules
Ambient conditions  Ambient temperature during operation  • min.  • max.  • horizontal installation, min.	-20 °C Up to 60 °C with max. 32 ET 200SP modules; up to 55 °C with max. 64 ET 200SP modules -20 °C
Ambient conditions  Ambient temperature during operation  • min.  • max.  • horizontal installation, min.  • horizontal installation, max.	-20 °C Up to 60 °C with max. 32 ET 200SP modules; up to 55 °C with max. 64 ET 200SP modules -20 °C 60 °C
Ambient conditions  Ambient temperature during operation  • min.  • max.  • horizontal installation, min.  • horizontal installation, max.  • vertical installation, min.	-20 °C Up to 60 °C with max. 32 ET 200SP modules; up to 55 °C with max. 64 ET 200SP modules -20 °C 60 °C -20 °C
Ambient conditions  Ambient temperature during operation  • min.  • max.  • horizontal installation, min.  • horizontal installation, max.  • vertical installation, min.  • vertical installation, max.	-20 °C Up to 60 °C with max. 32 ET 200SP modules; up to 55 °C with max. 64 ET 200SP modules -20 °C 60 °C
Ambient conditions  Ambient temperature during operation  • min.  • max.  • horizontal installation, min.  • horizontal installation, max.  • vertical installation, min.  • vertical installation, max.  Ambient temperature during storage/transportation	-20 °C Up to 60 °C with max. 32 ET 200SP modules; up to 55 °C with max. 64 ET 200SP modules -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules
Ambient conditions  Ambient temperature during operation  • min.  • max.  • horizontal installation, min.  • horizontal installation, max.  • vertical installation, min.  • vertical installation, max.  Ambient temperature during storage/transportation  • min.	-20 °C Up to 60 °C with max. 32 ET 200SP modules; up to 55 °C with max. 64 ET 200SP modules -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules
Ambient conditions  Ambient temperature during operation  • min.  • max.  • horizontal installation, min.  • horizontal installation, max.  • vertical installation, min.  • vertical installation, max.  Ambient temperature during storage/transportation  • min.  • max.	-20 °C Up to 60 °C with max. 32 ET 200SP modules; up to 55 °C with max. 64 ET 200SP modules -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules
Ambient conditions  Ambient temperature during operation  • min.  • max.  • horizontal installation, min.  • horizontal installation, max.  • vertical installation, min.  • vertical installation, max.  Ambient temperature during storage/transportation  • min.  • max.  Vibrations	-20 °C Up to 60 °C with max. 32 ET 200SP modules; up to 55 °C with max. 64 ET 200SP modules -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules  -40 °C 70 °C
Ambient conditions  Ambient temperature during operation  • min.  • max.  • horizontal installation, min.  • horizontal installation, max.  • vertical installation, min.  • vertical installation, max.  Ambient temperature during storage/transportation  • min.  • max.  Vibrations  • Operation, tested according to IEC 60068-2-6	-20 °C Up to 60 °C with max. 32 ET 200SP modules; up to 55 °C with max. 64 ET 200SP modules -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules  -40 °C 70 °C  Yes
Ambient conditions  Ambient temperature during operation  • min.  • max.  • horizontal installation, min.  • horizontal installation, max.  • vertical installation, min.  • vertical installation, max.  Ambient temperature during storage/transportation  • min.  • max.  Vibrations  • Operation, tested according to IEC 60068-2-6  • Transport, tested acc. to IEC 60068-2-6	-20 °C Up to 60 °C with max. 32 ET 200SP modules; up to 55 °C with max. 64 ET 200SP modules -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules  -40 °C 70 °C
Ambient conditions  Ambient temperature during operation  • min.  • max.  • horizontal installation, min.  • horizontal installation, max.  • vertical installation, min.  • vertical installation, max.  Ambient temperature during storage/transportation  • min.  • max.  Vibrations  • Operation, tested according to IEC 60068-2-6  • Transport, tested acc. to IEC 60068-2-6  Shock testing	-20 °C Up to 60 °C with max. 32 ET 200SP modules; up to 55 °C with max. 64 ET 200SP modules -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules  -40 °C 70 °C  Yes Yes
Ambient conditions  Ambient temperature during operation  • min.  • max.  • horizontal installation, min.  • horizontal installation, max.  • vertical installation, min.  • vertical installation, max.  Ambient temperature during storage/transportation  • min.  • max.  Vibrations  • Operation, tested according to IEC 60068-2-6  • Transport, tested acc. to IEC 60068-2-6  Shock testing  • tested according to IEC 60068-2-6	-20 °C Up to 60 °C with max. 32 ET 200SP modules; up to 55 °C with max. 64 ET 200SP modules -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules  -40 °C 70 °C  Yes Yes
Ambient conditions  Ambient temperature during operation  • min.  • max.  • horizontal installation, min.  • horizontal installation, max.  • vertical installation, min.  • vertical installation, max.  Ambient temperature during storage/transportation  • min.  • max.  Vibrations  • Operation, tested according to IEC 60068-2-6  • Transport, tested acc. to IEC 60068-2-6  Shock testing  • tested according to IEC 60068-2-6  • tested according to IEC 60068-2-7	-20 °C Up to 60 °C with max. 32 ET 200SP modules; up to 55 °C with max. 64 ET 200SP modules -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules  -40 °C 70 °C  Yes Yes Yes
Ambient conditions  Ambient temperature during operation  • min.  • max.  • horizontal installation, min.  • horizontal installation, max.  • vertical installation, min.  • vertical installation, max.  Ambient temperature during storage/transportation  • min.  • max.  Vibrations  • Operation, tested according to IEC 60068-2-6  • Transport, tested acc. to IEC 60068-2-6  Shock testing  • tested according to IEC 60068-2-7  • tested according to IEC 60068-2-29	-20 °C Up to 60 °C with max. 32 ET 200SP modules; up to 55 °C with max. 64 ET 200SP modules -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules  -40 °C 70 °C  Yes Yes Yes Yes
Ambient conditions  Ambient temperature during operation  • min.  • max.  • horizontal installation, min.  • horizontal installation, max.  • vertical installation, min.  • vertical installation, max.  Ambient temperature during storage/transportation  • min.  • max.  Vibrations  • Operation, tested according to IEC 60068-2-6  • Transport, tested acc. to IEC 60068-2-6  Shock testing  • tested according to IEC 60068-2-7  • tested according to IEC 60068-2-27  • tested according to IEC 60068-2-29  • Storage/transport, tested acc. to IEC 60068-2-27	-20 °C  Up to 60 °C with max. 32 ET 200SP modules; up to 55 °C with max. 64  ET 200SP modules  -20 °C  60 °C  -20 °C  50 °C; With max. 32 ET 200SP modules  -40 °C  70 °C  Yes  Yes  Yes
Ambient conditions  Ambient temperature during operation  min. max.  horizontal installation, min. horizontal installation, max. vertical installation, min. vertical installation, max.  Ambient temperature during storage/transportation  min. max.  Vibrations  Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6  Shock testing  tested according to IEC 60068-2-7  tested according to IEC 60068-2-27  tested according to IEC 60068-2-29 Storage/transport, tested acc. to IEC 60068-2-27  Storage/transport, tested acc. to IEC 60068-2-27	-20 °C  Up to 60 °C with max. 32 ET 200SP modules; up to 55 °C with max. 64 ET 200SP modules -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules  -40 °C 70 °C  Yes Yes Yes Yes Yes Yes
Ambient conditions  Ambient temperature during operation  • min.  • max.  • horizontal installation, min.  • horizontal installation, max.  • vertical installation, min.  • vertical installation, max.  Ambient temperature during storage/transportation  • min.  • max.  Vibrations  • Operation, tested according to IEC 60068-2-6  • Transport, tested acc. to IEC 60068-2-6  Shock testing  • tested according to IEC 60068-2-7  • tested according to IEC 60068-2-27  • tested according to IEC 60068-2-29  • Storage/transport, tested acc. to IEC 60068-2-27  Operating systems  pre-installed operating system	-20 °C Up to 60 °C with max. 32 ET 200SP modules; up to 55 °C with max. 64 ET 200SP modules -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules  -40 °C 70 °C  Yes Yes Yes Yes
Ambient conditions  Ambient temperature during operation  • min. • max.  • horizontal installation, min. • horizontal installation, max. • vertical installation, min. • vertical installation, max.  Ambient temperature during storage/transportation • min. • max.  Vibrations • Operation, tested according to IEC 60068-2-6 • Transport, tested acc. to IEC 60068-2-6  Shock testing • tested according to IEC 60068-2-7 • tested according to IEC 60068-2-27 • tested according to IEC 60068-2-29 • Storage/transport, tested acc. to IEC 60068-2-27  Operating systems  pre-installed operating system  Configuration	-20 °C  Up to 60 °C with max. 32 ET 200SP modules; up to 55 °C with max. 64 ET 200SP modules -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules  -40 °C 70 °C  Yes Yes Yes Yes Yes Yes
Ambient conditions  Ambient temperature during operation  min.  max.  horizontal installation, min.  horizontal installation, max.  vertical installation, min.  vertical installation, max.  Ambient temperature during storage/transportation  min.  max.  Vibrations  Operation, tested according to IEC 60068-2-6  Transport, tested acc. to IEC 60068-2-6  Transport, tested acc. to IEC 60068-2-7  tested according to IEC 60068-2-7  tested according to IEC 60068-2-27  tested according to IEC 60068-2-29  Storage/transport, tested acc. to IEC 60068-2-27  Operating systems  pre-installed operating system  Configuration  Programming	-20 °C  Up to 60 °C with max. 32 ET 200SP modules; up to 55 °C with max. 64 ET 200SP modules -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules  -40 °C 70 °C  Yes Yes Yes Yes Yes Yes
Ambient conditions  Ambient temperature during operation  • min. • max.  • horizontal installation, min. • horizontal installation, max. • vertical installation, min. • vertical installation, max.  Ambient temperature during storage/transportation • min. • max.  Vibrations  • Operation, tested according to IEC 60068-2-6 • Transport, tested acc. to IEC 60068-2-6  Shock testing • tested according to IEC 60068-2-7 • tested according to IEC 60068-2-27 • tested according to IEC 60068-2-29 • Storage/transport, tested acc. to IEC 60068-2-27  Operating systems  pre-installed operating system  Configuration  Programming  Programming language	-20 °C Up to 60 °C with max. 32 ET 200SP modules; up to 55 °C with max. 64 ET 200SP modules -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules  -40 °C 70 °C  Yes Yes Yes Yes Yes Yes Yes Yes Yes
Ambient conditions  Ambient temperature during operation  • min.  • max.  • horizontal installation, min.  • horizontal installation, max.  • vertical installation, min.  • vertical installation, max.  Ambient temperature during storage/transportation  • min.  • max.  Vibrations  • Operation, tested according to IEC 60068-2-6  • Transport, tested acc. to IEC 60068-2-6  Shock testing  • tested according to IEC 60068-2-7  • tested according to IEC 60068-2-7  • tested according to IEC 60068-2-27  • tested according to IEC 60068-2-27  • tested according to IEC 60068-2-29  • Storage/transport, tested acc. to IEC 60068-2-27  Operating systems  pre-installed operating system  Configuration  Programming  Programming  Programming language  — LAD	-20 °C Up to 60 °C with max. 32 ET 200SP modules; up to 55 °C with max. 64 ET 200SP modules -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules  -40 °C 70 °C  Yes Yes Yes Yes Yes Yes Yes Yes Yes
Ambient conditions  Ambient temperature during operation  • min. • max.  • horizontal installation, min. • horizontal installation, max. • vertical installation, min. • vertical installation, max.  Ambient temperature during storage/transportation • min. • max.  Vibrations  • Operation, tested according to IEC 60068-2-6 • Transport, tested acc. to IEC 60068-2-6  Shock testing • tested according to IEC 60068-2-7 • tested according to IEC 60068-2-27 • tested according to IEC 60068-2-29 • Storage/transport, tested acc. to IEC 60068-2-27  Operating systems  pre-installed operating system  Configuration  Programming  Programming language	-20 °C Up to 60 °C with max. 32 ET 200SP modules; up to 55 °C with max. 64 ET 200SP modules -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules  -40 °C 70 °C  Yes Yes Yes Yes Yes Yes Yes Yes Yes

— SCL	Yes	
— CFC	No	
— GRAPH	Yes	
Know-how protection		
<ul> <li>User program protection/password protection</li> </ul>	Yes	
<ul> <li>Copy protection</li> </ul>	Yes	
Block protection	Yes	
Access protection		
<ul> <li>Protection level: Write protection</li> </ul>	Yes	
<ul> <li>Protection level: Read/write protection</li> </ul>	Yes	
Protection level: Complete protection	Yes	
Cycle time monitoring		
<ul> <li>lower limit</li> </ul>	adjustable minimum cycle time	
• upper limit	adjustable maximum cycle time	
Open Development interfaces		
<ul> <li>Size of ODK SO file, max.</li> </ul>	5.8 Mbyte	
Peripherals/Options		
SD card	Optionally for additional mass storage	
Dimensions		
Width	160 mm	
Height	117 mm	
Depth	75 mm	
Weights		
Weight, approx.	0.83 kg	
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